

# High Performance Schottky Rectifier, 1 A



DO-214AC (SMA)



## FEATURES

- Low forward voltage drop
- Guard ring for enhanced ruggedness and long term reliability
- Small foot print, surface mountable
- High frequency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


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COMPLIANT

## DESCRIPTION

The VS-MBRA140TRPbF surface mount Schottky rectifier has been designed for applications requiring low forward drop and very small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

## PRODUCT SUMMARY

Package	DO-214AC (SMA)
$I_{F(AV)}$	1 A
$V_R$	40 V
$V_F$ at $I_F$	0.49 V
$I_{RM}$	26 mA at 125 °C
$T_J$ max.	150 °C
Diode variation	Single die
$E_{AS}$	3.0 mJ

## MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Rectangular waveform	1	A
$V_{RRM}$		40	V
$I_{FSM}$	$t_p = 5 \mu s$ sine	120	A
$V_F$	1.5 A <sub>pk</sub> , $T_J = 125$ °C	0.56	V
$T_J$	Range	-55 to +150	°C

## VOLTAGE RATINGS

PARAMETER	SYMBOL	VS-MBRA140TRPBF	UNITS
Maximum DC reverse voltage	$V_R$	40	V
Maximum working peak reverse voltage	$V_{RWM}$		

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current See fig. 4	$I_{F(AV)}$	50 % duty cycle at $T_L = 123$ °C, rectangular waveform On PC board 9 mm <sup>2</sup> island (0.013 mm thick copper pad area)	1.5	A
		50 % duty cycle at $T_L = 132$ °C, rectangular waveform On PC board 9 mm <sup>2</sup> island (0.013 mm thick copper pad area)	1	
Maximum peak one cycle non-repetitive surge current See fig. 6	$I_{FSM}$	5 $\mu s$ sine or 3 $\mu s$ rect. pulse	120	A
		10 ms sine or 6 ms rect. pulse	30	
Non-repetitive avalanche energy	$E_{AS}$	$T_J = 25$ °C, $I_{AS} = 1$ A, $L = 6$ mH	3.0	mJ
Repetitive avalanche current	$I_{AR}$	Current decaying linearly to zero in 1 $\mu s$ Frequency limited by $T_J$ maximum $V_A = 1.5 \times V_R$ typical	1.0	A



ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop See fig. 1	V <sub>FM</sub> <sup>(1)</sup>	1 A	T <sub>J</sub> = 25 °C	0.54	V
		1.5 A		0.62	
		1 A	T <sub>J</sub> = 125 °C	0.49	
		1.5 A		0.56	
Maximum reverse leakage current See fig. 2	I <sub>RM</sub>	T <sub>J</sub> = 25 °C	V <sub>R</sub> = Rated V <sub>R</sub>	0.5	mA
		T <sub>J</sub> = 125 °C		26	
Threshold voltage	V <sub>F(TO)</sub>	T <sub>J</sub> = T <sub>J</sub> maximum		0.36	V
Forward slope resistance	r <sub>t</sub>			104	mΩ
Typical junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 10 V <sub>DC</sub> , T <sub>J</sub> = 25 °C, test signal = 1 MHz		38	pF
Typical series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body		2.0	nH
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>		10 000	V/μs

**Note**(1) Pulse width = 300  $\mu$ s, duty cycle = 2 %

THERMAL - MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	$T_J^{(1)}$ , $T_{Stg}$		-55 to +150	$^{\circ}\text{C}$
Maximum thermal resistance, junction to ambient	$R_{thJA}$	DC operation	80	$^{\circ}\text{C/W}$
Approximate weight			0.07	g
			0.002	oz.
Marking device		Case style SMA (similar D-64)	1F	

**Note**(1)  $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$  thermal runaway condition for a diode on its own heatsink

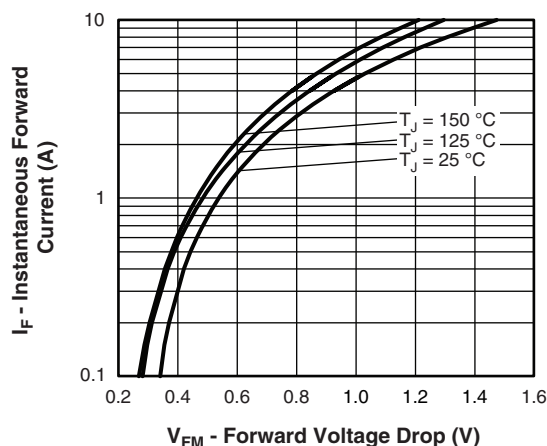


Fig. 1 - Maximum Forward Voltage Drop Characteristics

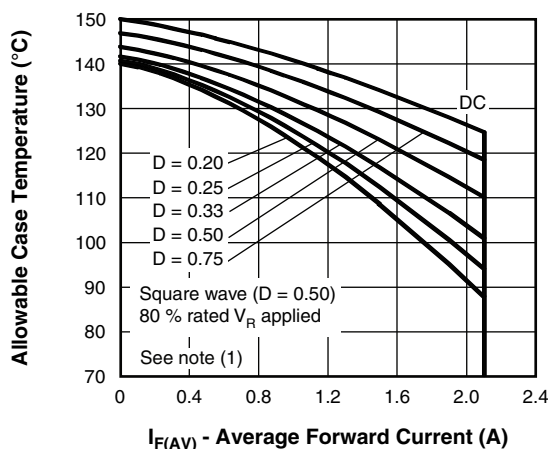


Fig. 4 - Maximum Average Forward Current vs. Allowable Lead Temperature

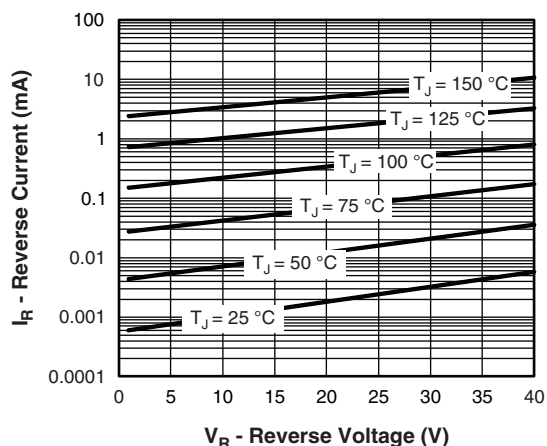


Fig. 2 - Typical Peak Reverse Current vs. Reverse Voltage

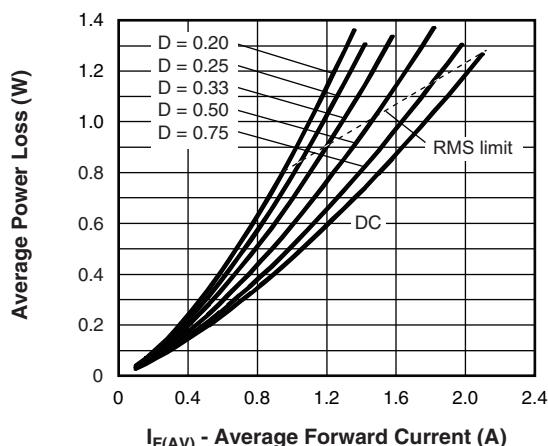


Fig. 5 - Maximum Average Forward Dissipation vs. Average Forward Current

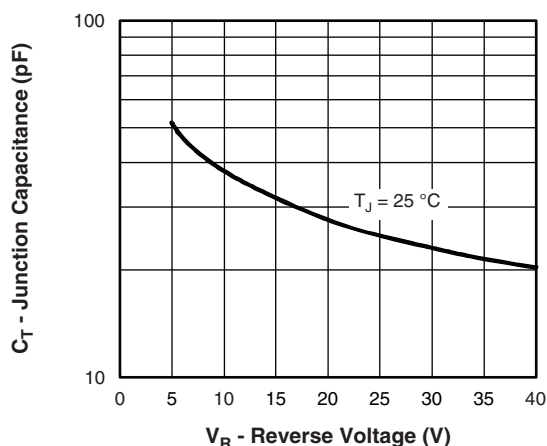


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

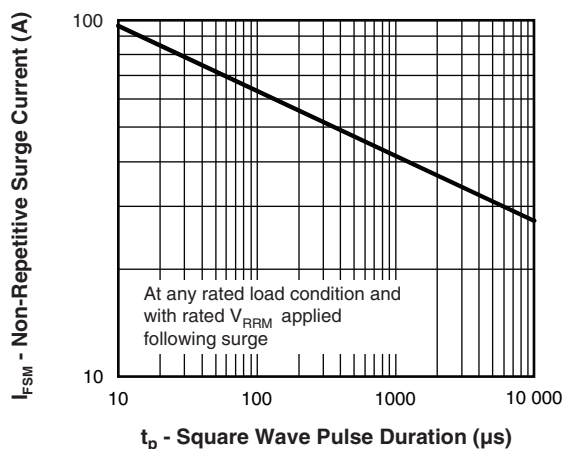


Fig. 6 - Maximum Peak Surge Forward Current vs. Pulse Duration

#### Note

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);  $P_{dREV}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1} = 80\%$  rated  $V_R$

## ORDERING INFORMATION TABLE

Device code	<b>VS-</b>	<b>MBR</b>	<b>A</b>	<b>1</b>	<b>40</b>	<b>TR</b>	<b>PbF</b>
	1	2	3	4	5	6	7

- 1 - Vishay Semiconductors product
- 2 - Schottky MBR series
- 3 - A = SMA
- 4 - Current rating (1 = 1A)
- 5 - Voltage rating (40 = 40 V)
- 6 TR = tape and reel (7500 pcs)
- 7 PbF = terminations lead (Pb)-free

### ORDERING INFORMATION (Example)

PREFERRED P/N	PREFERRED PACKAGE CODE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-MBRA140TRPbF	5AT	7500	13" diameter plastic tape and reel

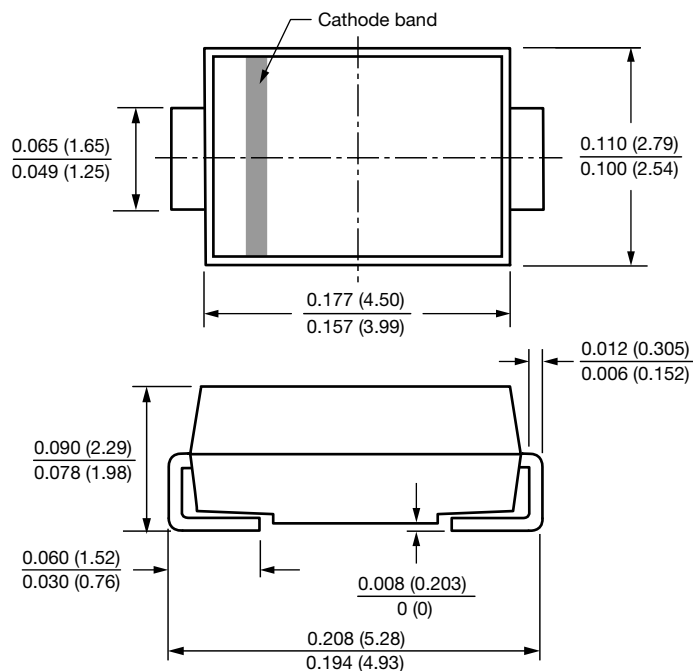
## LINKS TO RELATED DOCUMENTS

Dimensions	<a href="http://www.vishay.com/doc?95400">www.vishay.com/doc?95400</a>
Part marking information	<a href="http://www.vishay.com/doc?95403">www.vishay.com/doc?95403</a>
Packaging information	<a href="http://www.vishay.com/doc?95404">www.vishay.com/doc?95404</a>
SPICE model	<a href="http://www.vishay.com/doc?96008">www.vishay.com/doc?96008</a>

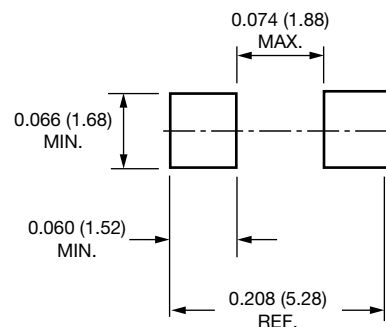
## SMA

**DIMENSIONS** in inches (millimeters)

**DO-214AC (SMA)**



**Mounting Pad Layout**





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